Amendments to the Claims

 (Currently Amended) A high frequency semiconductor device having a shifted doping profile, comprising:

a buried oxide layer formed over a semiconductor substrate; and

a silicon layer formed over the buried oxide layer, wherein the silicon layer comprises a body region, a source region formed on the body region, a drain region, and a drift region extending between the body region and the drain region, wherein an origin of a doping profile of the silicon layer is within a the body region of the device and has a dopant level of approximately zero.

- 2. (Cancelled).
- 3. (Original) The device of claim 1, further comprising a top oxide layer, wherein the origin of the doping profile is offset approximately 2 to 4μm from an edge of the top oxide layer.
- 4. (Original) The device of claim 1, further comprising a field plate formed over the top oxide layer and a plate oxide layer formed over the field plate.
- (Original) The device of claim 4, further comprising a source metal, a gate metal, and a drain metal formed over the silicon layer.

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- 6. (Original) The device of claim 1, wherein the doping profile is linear.
- 7. (Original) The device of claim 1, wherein the doping profile is non-linear.
- (Currently Amended) A high frequency semiconductor device having a shifted doping profile, comprising:

a buried oxide layer formed over a semiconductor substrate;

a silicon layer formed over the buried oxide layer, wherein the silicon layer comprises a source region, a body region, a drift region, and a drain region body region, a source region formed on the body region, a drain region, and a drift region extending between the body region and the drain region; and

a top oxide layer formed over the silicon layer, wherein a doping profile of the silicon layer has an origin that has a dopant level of approximately zero, and wherein the origin is within the body region, approximately 2 to $4\mu m$ from an edge of the top oxide layer.

- 9. (Original) The device of claim 8, wherein the doping profile is linear.
- 10. (Original) The device of claim 8, wherein the doping profile is non-linear.
- 11. (Original) The device of claim 8, further comprising a field plate formed over the top oxide layer and a plate oxide layer formed over the field plate.

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- 12. (Original) The device of claim 11, further comprising a source metal, a gate metal, a drain metal formed over the silicon layer.
- 13. (Original) The device of claim 8, wherein the device has a transconductance approximately 15% higher and a maximum current approximately 45% higher than a device having a doping profile origin approximately aligned with the edge of the top oxide layer.